

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
100V	15mΩ@10V	8A
	18mΩ@4.5V	

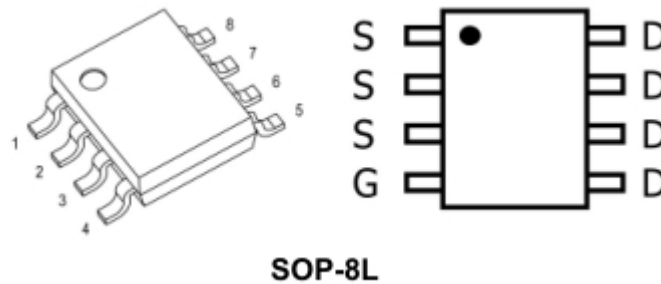
## Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

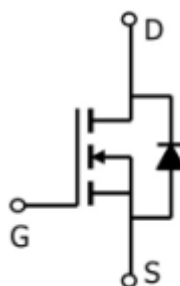
## Application

- Power switching application
- DC-DC Converter

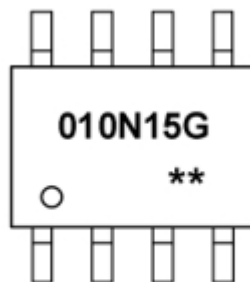
## Package



## Circuit diagram



## Marking



**010N15G**      =Device Code  
**\*\***                =Week Code

## Absolute maximum ratings

(T<sub>a</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current (T <sub>c</sub> =25°C)	I <sub>D</sub>	8	A
Pulsed Drain Current <sup>1</sup>	I <sub>DM</sub>	32	A
Single Pulse Avalanche Energy <sup>2</sup>	E <sub>AS</sub>	81	mJ
Total Power Dissipation	P <sub>D</sub>	2.5	W
Thermal Resistance Junction-Ambient	R <sub>θJA</sub>	50	°C/ W
Storage Temperature Range	T <sub>STG</sub>	-55~ +150	°C
Operating Junction Temperature Range	T <sub>J</sub>	-55~ +150	°C

## Electrical characteristics

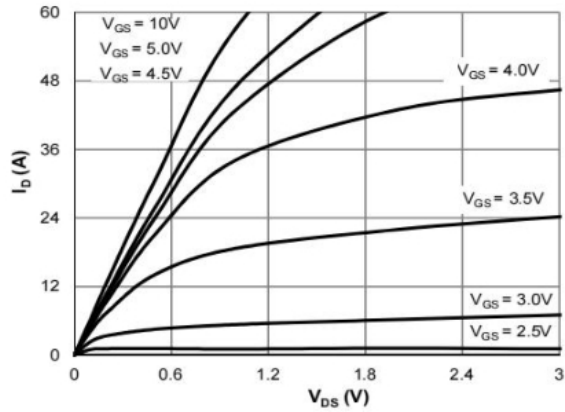
( $T_A=25^{\circ}\text{C}$ , unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	100			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =80V,V <sub>GS</sub> = 0V , T <sub>J</sub> =25℃			1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V , V <sub>DS</sub> =0V			±100	uA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1	1.8	2.5	V
Static Drain-Source on-Resistance <sup>2</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =8A		15	19	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A		18	24	
Dynamic characteristics						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V, f=1MHz		2071		pF
Output Capacitance	C <sub>oss</sub>			241		
Reverse Transfer Capacitance	C <sub>rss</sub>			21		
Switching Characteristics						
Total Gate Charge (4.5V)	Q <sub>g</sub>	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, I <sub>D</sub> =5A		12.5		nC
Gate-Source Charge	Q <sub>gS</sub>			2.1		
Gate-Drain Charge	Q <sub>gd</sub>			3.3		
Turn-On Delay Time	T <sub>d(on)</sub>	V <sub>DD</sub> =50V, V <sub>GS</sub> =10V, R <sub>G</sub> =3Ω, I <sub>D</sub> =5A		4.3		nS
Rise Time	T <sub>r</sub>			5.1		
Turn-Off Delay Time	T <sub>d(off)</sub>			16		
Fall Time	T <sub>f</sub>			7		
Drain-Source Diode Characteristics						
Diode forward voltage <sup>2</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =1A, T <sub>J</sub> =25℃			1.2	V

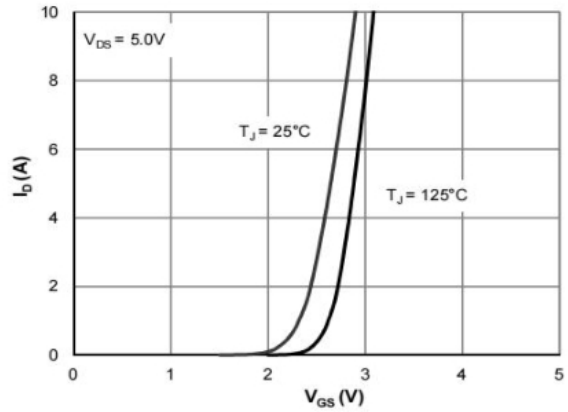
**Notes:**

1. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
2. The EAS data shows Max. rating . The test condition is  $V_{DD} = 50V, V_{GS} = 10V, L = 0.5mH, R_g = 25m\Omega$

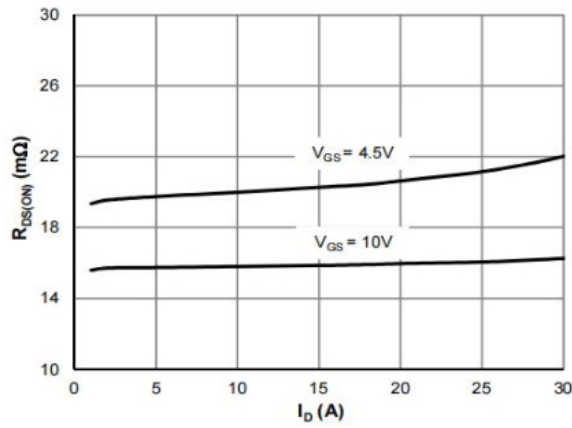
## Typical Characteristics



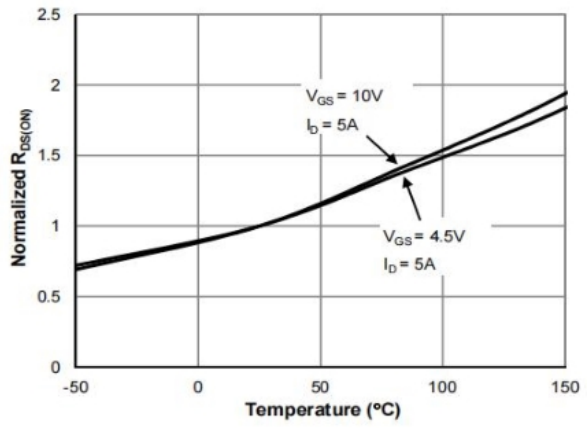
Typical Output Characteristics



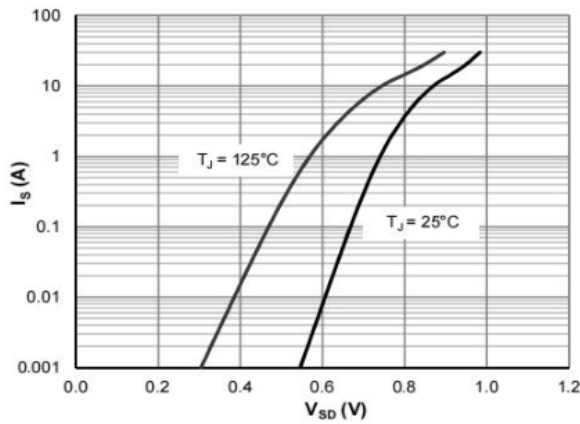
Transfer Characteristics



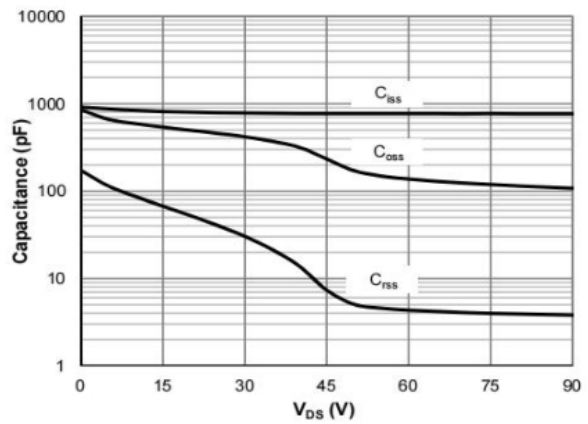
On-Resistance vs. Drain Current



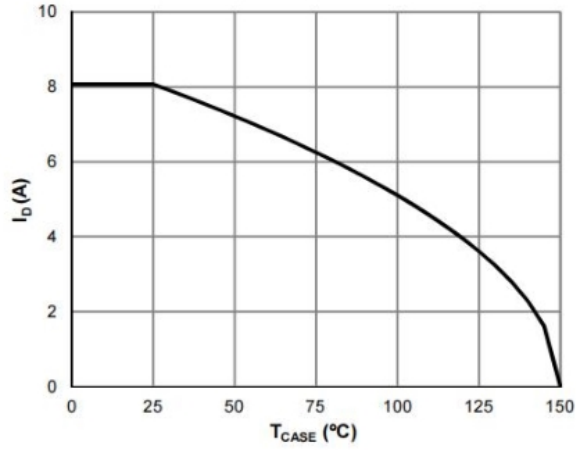
On-Resistance vs. Junction Temperature



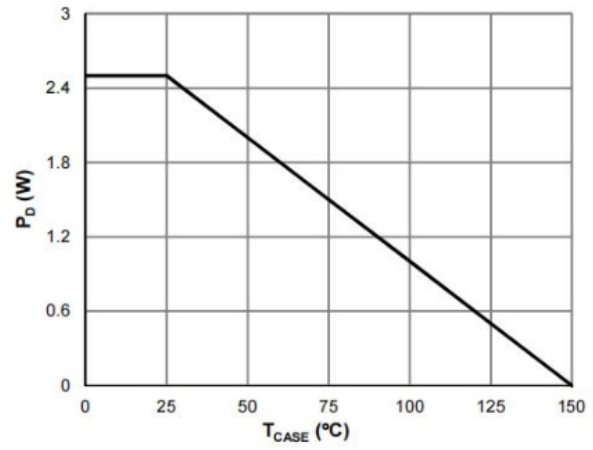
Body-Diode Characteristics



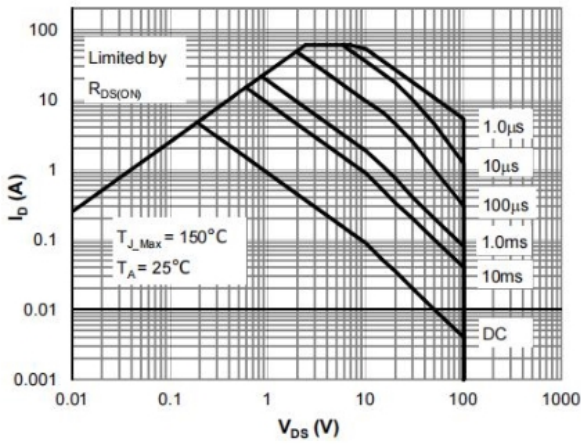
Capacitance Characteristics



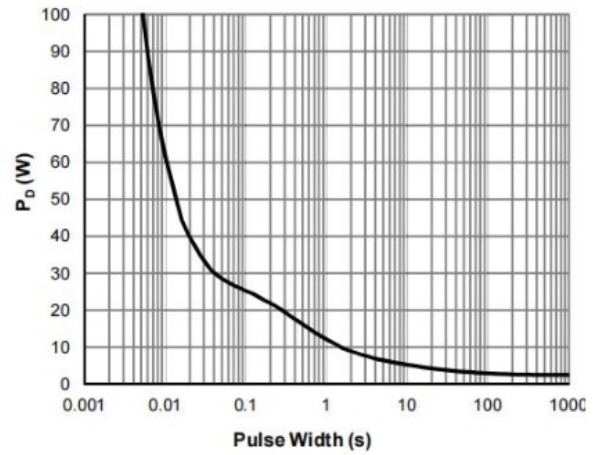
Current De-rating



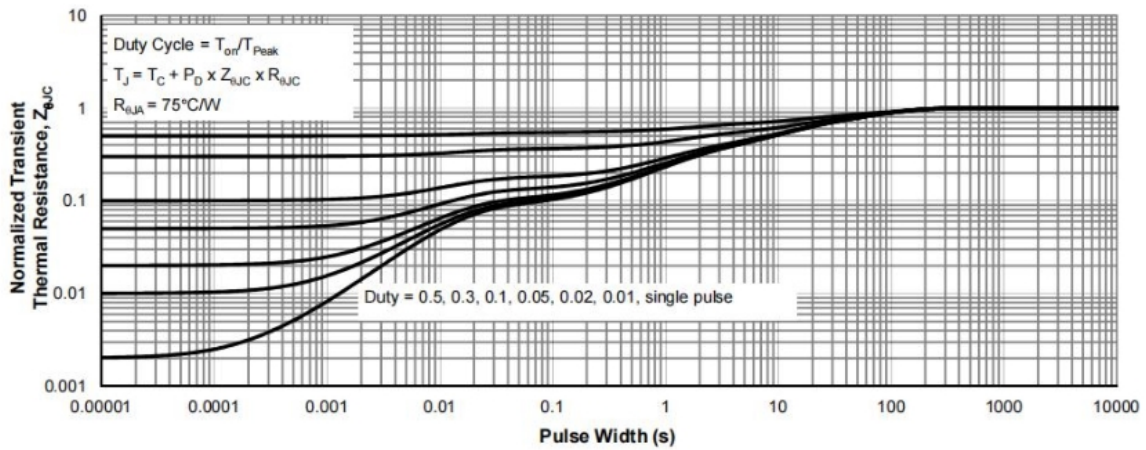
Power De-rating



Maximum Safe Operating Area

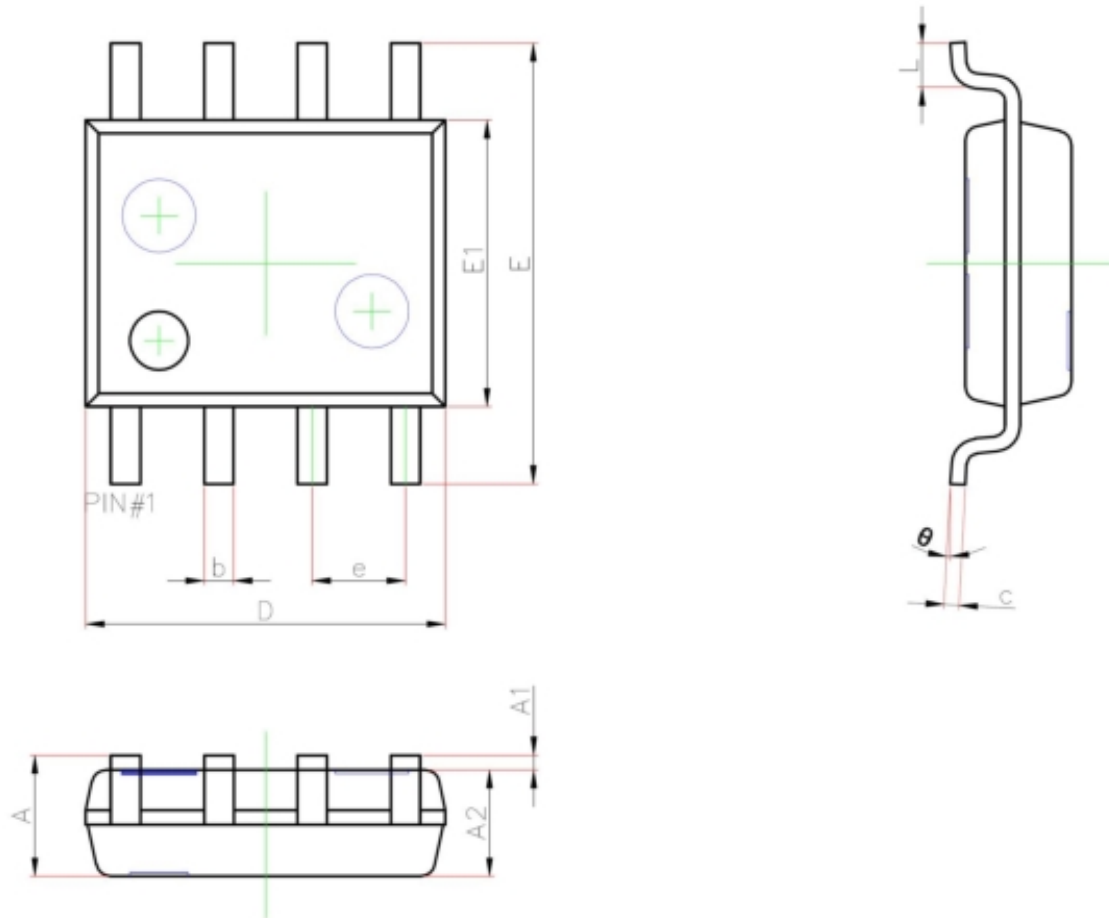


Single Pulse Power Rating, Junction-to-Case



Normalized Maximum Transient Thermal Impedance

## SOP-8 Package Information



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	1.35	1.75
A1	0.10	0.25
A2	1.35	1.55
b	0.33	0.51
c	0.17	0.25
D	4.80	5.00
e	1.27 REF.	
E	5.80	6.20
E1	3.80	4.00
L	0.40	1.27
$\theta$	0°	8°